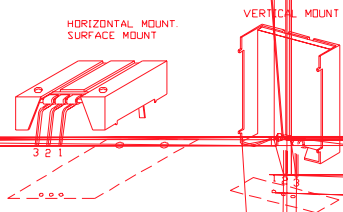
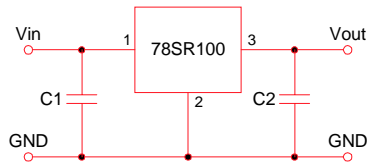


For assistance or to order, call



SUGGESTED BOARD LAYOUT
COMPONENT SIDE VIEW
Pkg Style 500

0 — 5 — G's

20-2000 Hz, soldered in a PC board

Weight — — — 6.5 — grams

*ISR will operate down to no load with reduced specifications.

**See Thermal Derating chart.



CHARACTERISTIC DATA

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Samples (Reqd)
78SR105HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR105SC	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
78SR105SCT			78SR105SCT						

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
78SR110VC	OBSOLETE	SIP MODULE	EFD	3		TBD	Call TI	Call TI	
78SR112HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR112SC	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
78SR112SCT	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR112TC	LIFEBUY	SIP MODULE	EFT	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR112VC	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR114HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR114SC	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR114SCT	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR114VC	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR114WC	OBSOLETE	SIP MODULE	EFW	3		TBD	Call TI	Call TI	
78SR115HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR115SC	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR115SCT	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR115VC	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR153HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR153SC	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
78SR153SCT	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
78SR153TC	OBSOLETE	SIP MODULE	EFT	3		TBD	Call TI	Call TI	
78SR153VC	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR174HC	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
78SR174SC	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	

Orderable Device	Status	Package Type	
	(1)		

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps